BOARD CHARACTERISTICS

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Copper Layer Count:	4	Board Thickness:	1.6064 mm
Board overall dimensions:	140.0000 mm x 73.0000 mm		
Min track/spacing:	0.0000 mm / 0.0000 mm	Min hole diameter:	0.1000 mm
Copper Finish:	None	Impedance Control:	No
Castellated pads:	No	Plated Board Edge:	No
Edge card connectors:	No		

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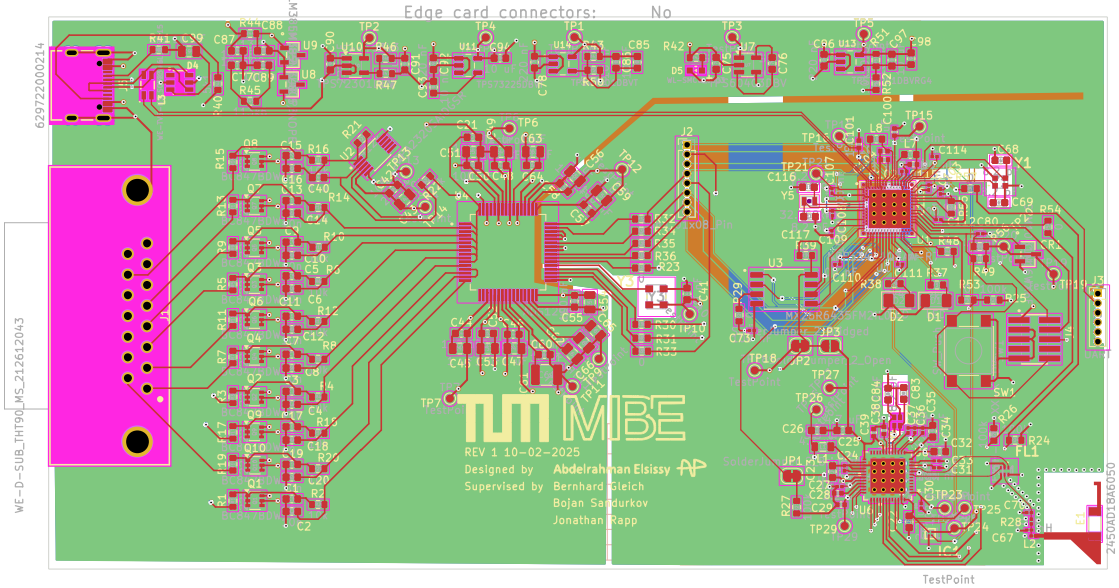

Sheet: File: 12_Channel_ECG.kicad_pcb		
Title:		
Size: A4	Date:	**Rev:**
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